

FDD6N25

N-Channel UniFETTM MOSFET 250 V, 4.4 A, 1.1 Ω

Features

- + $R_{DS(on)}$ = 1.1 Ω (Max.) @ V_{GS} = 10 V, I_D = 2.2 A
- Low Gate Charge (Typ. 4.5 nC)
- Low C_{rss} (Typ. 5 pF)
- 100% Avalanche Tested

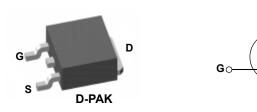
Applications

- LCD/LED/PDP TV
- Consumer Appliances
- Lighting
- Uninterruptible Power Supply
- AC-DC Power Supply

Description

UniFETTM MOSFET is Fairchild Semiconductor[®]'s high voltage MOSFET family based on planar stripe and DMOS technology. This MOSFET is tailored to reduce on-state resistance, and to provide better switching performance and higher avalanche energy strength. This device family is suitable for switching power converter applications such as power factor correction (PFC), flat panel display (FPD) TV power, ATX and electronic lamp ballasts.

March 2013



Absolute Maximum Ratings

Symbol	ol Parameter Drain-Source Voltage			FDD6N25	Unit	
V _{DSS}			tage 250		V	
I _D	Drain Current - Continuous $(T_C = 25^{\circ}C)$ - Continuous $(T_C = 100^{\circ}C)$			4.4 2.6	A A	
I _{DM}	Drain Current	- Pulsed	(Note 1)	18	A	
V _{GSS}	Gate-Source voltage			±30	V	
E _{AS}	Single Pulsed Avalanche Energy		(Note 2)	45	mJ	
I _{AR}	Avalanche Current		(Note 1)	4.4	A	
E _{AR}	Repetitive Avalanche Energy		(Note 1)	5	mJ	
dv/dt	Peak Diode Recovery dv/dt		(Note 3)	4.5	V/ns	
P _D	Power Dissipation $(T_C = 25^{\circ}C)$ - Derate above $25^{\circ}C$			50 0.4	W W/°C	
T _{J,} T _{STG}	Operating and Storage Temperature Range			-55 to +150	°C	
TL	Maximum Lead Temperature for Soldering Purpose, 1/8" from Case for 5 Seconds		e,	300	°C	

Thermal Characteristics

Symbol	Parameter	FDD6N25	Unit
$R_{ ext{ heta}JC}$	Thermal Resistance, Junction-to-Case, Max.	2.5	°C/W
$R_{ hetaJA}$	Thermal Resistance, Junction-to-Ambient, Max.	110	C/W

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Package Marking and Ordering Information

Device Marking	Device	Package	Reel Size	Tape Width	Quantity
FDD6N25	FDD6N25TM	D-PAK	380mm	16mm	2500

Electrical Characteristics T_c = 25°C unless otherwise noted

Symbol	Parameter Conditions		Min.	Тур.	Max	Unit
Off Charac	teristics					
BV _{DSS}	Drain-Source Breakdown Voltage	V _{GS} = 0V, I _D = 250μA	250			V
ΔBV _{DSS} / ΔT _J	Breakdown Voltage Temperature Coefficient			0.25		V/°C
I _{DSS}	Zero Gate Voltage Drain Current	$V_{DS} = 250V, V_{GS} = 0V$ $V_{DS} = 200V, T_{C} = 125^{\circ}C$			1 10	μΑ μΑ
I _{GSSF}	Gate-Body Leakage Current, Forward	V _{GS} = 30V, V _{DS} = 0V			100	nA
I _{GSSR}	Gate-Body Leakage Current, Reverse	V _{GS} = -30V, V _{DS} = 0V			-100	nA
On Charac	teristics					
V _{GS(th)}	Gate Threshold Voltage	$V_{DS} = V_{GS}, I_D = 250 \mu A$	3.0		5.0	V
R _{DS(on)}	Static Drain-Source On-Resistance	V _{GS} = 10V, I _D = 2.2A		0.9	1.1	Ω
9 _{FS}	Forward Transconductance V_{DS} = 40V, I_D = 2.2A			5.5		S
Dynamic C	Characteristics					
C _{iss}	Input Capacitance	V_{DS} = 25V, V_{GS} = 0V,		194	250	pF
C _{oss}	Output Capacitance	f = 1.0MHz		38	50	pF
C _{rss}	Reverse Transfer Capacitance			5	8	pF
Switching	Characteristics					
t _{d(on)}	Turn-On Delay Time	V _{DD} = 125V, I _D = 6A		10	30	ns
t _r	Turn-On Rise Time	R _G = 25Ω		25	60	ns
t _{d(off)}	Turn-Off Delay Time			7	24	ns
t _f	Turn-Off Fall Time	(Note 4)		12	34	ns
Qg	Total Gate Charge	V _{DS} = 200V, I _D = 6A		4.5	6	nC
Q _{gs}	Gate-Source Charge	V _{GS} = 10V		1.5		nC
Q _{gd}	Gate-Drain Charge	(Note 4)		1.8		nC
Drain-Sour	rce Diode Characteristics and Maximur	n Ratings				
S Maximum Continuous Drain-Source Diode Forward Current				4.4	А	
I _{SM}	Maximum Pulsed Drain-Source Diode Forward Current				18	А
V _{SD}	Drain-Source Diode Forward Voltage	V _{GS} = 0V, I _S = 4.4A			1.4	V
t _{rr}	Reverse Recovery Time	V _{GS} = 0V, I _S = 6A		145		ns
Q _{rr}	Reverse Recovery Charge	dI _F /dt =100A/µs		0.55		μC

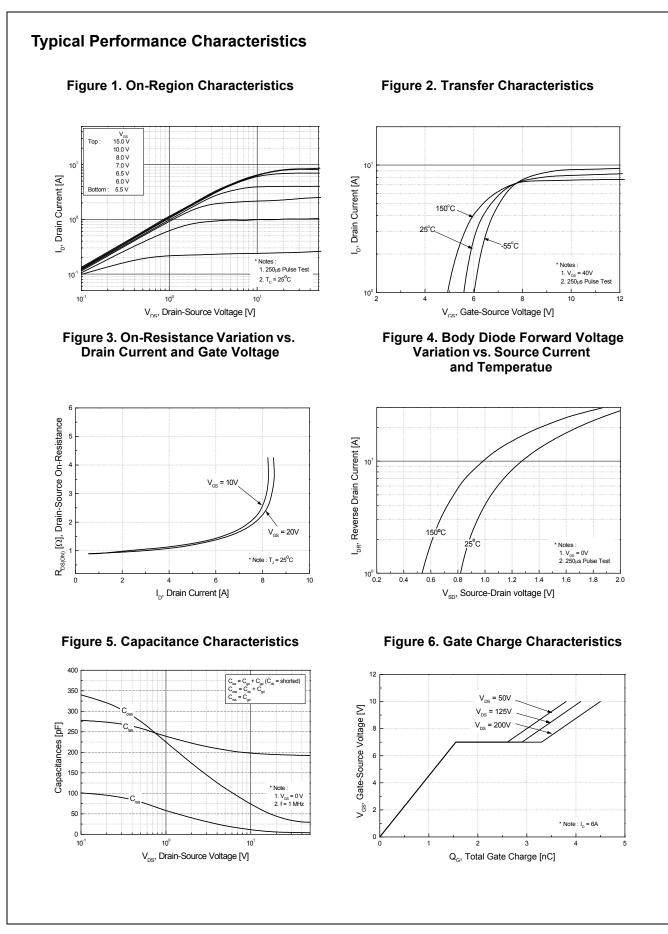
NOTES:

1. Repetitive Rating: Pulse width limited by maximum junction temperature

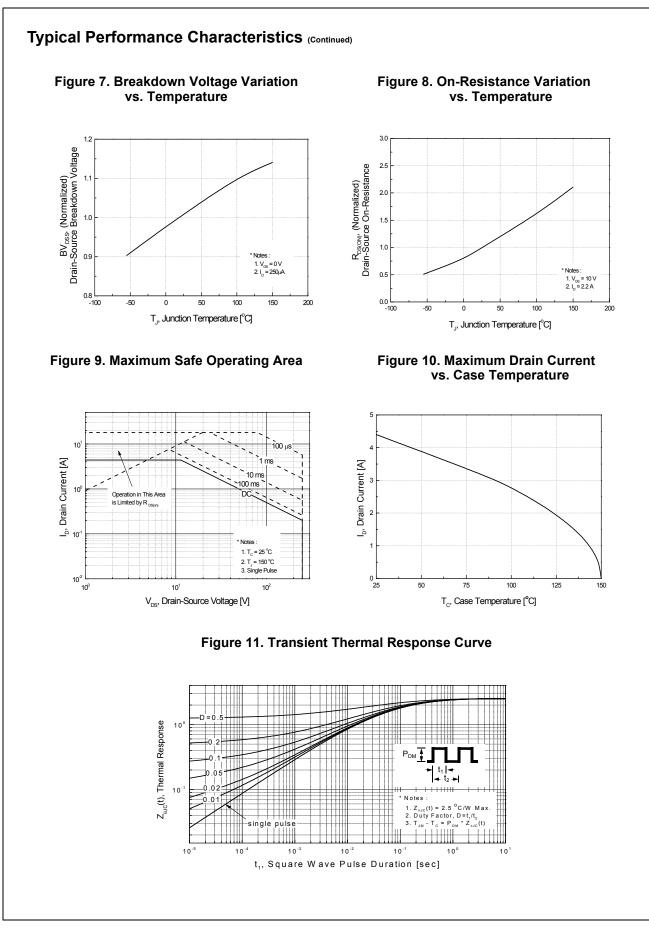
2. L = 3.7mH, I_{AS} = 4.4A, V_{DD} = 50V, R_G = 25 Ω , Starting T_J = 25°C

3. I_{SD} \leq 4.4 \text{A}, di/dt \leq 200 \text{A}/\mu\text{s}, \text{V}_{DD} \leq \text{BV}_{DSS}, \text{ Starting T}_{J} = 25°C

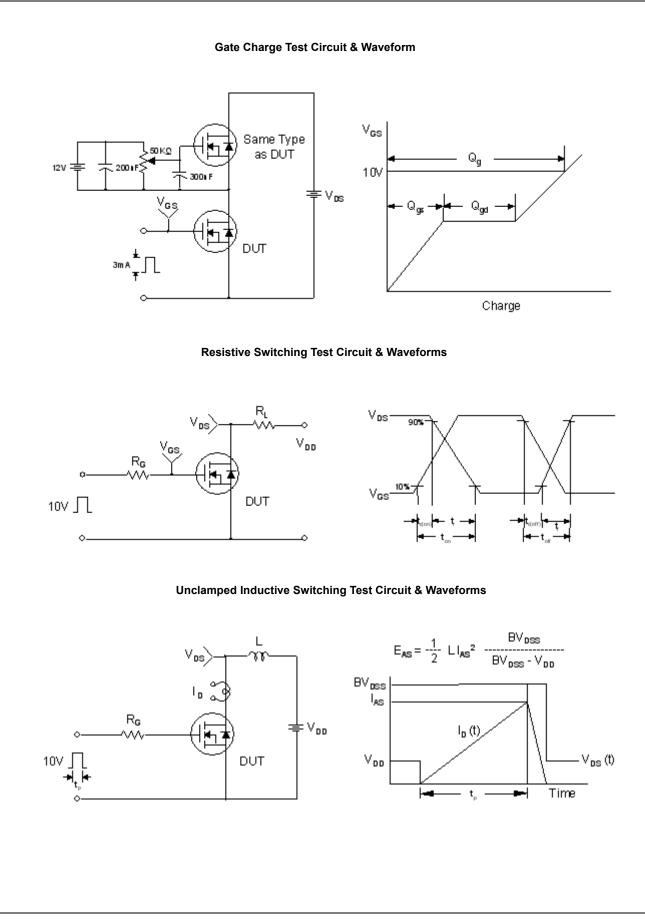
4. Essentially Independent of Operating Temperature Typical Characteristics



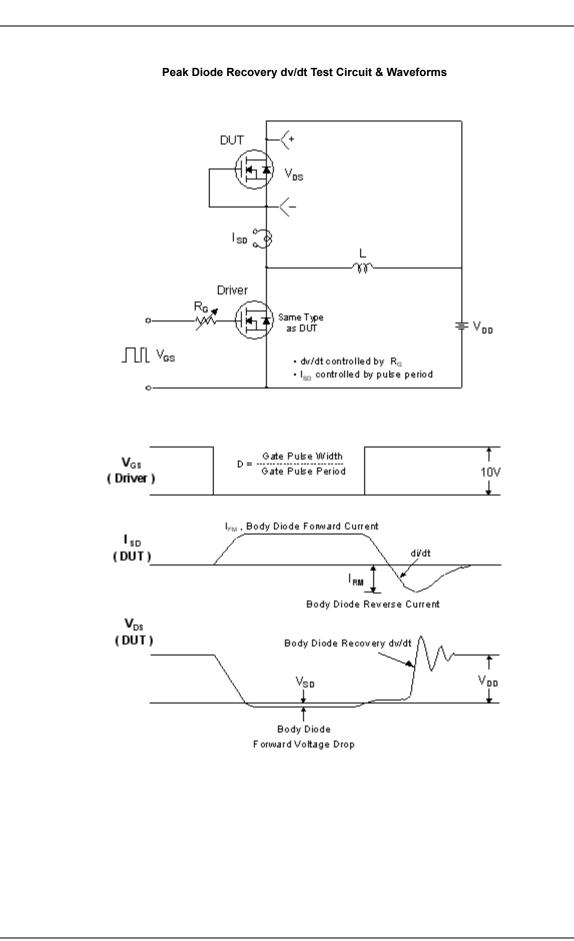
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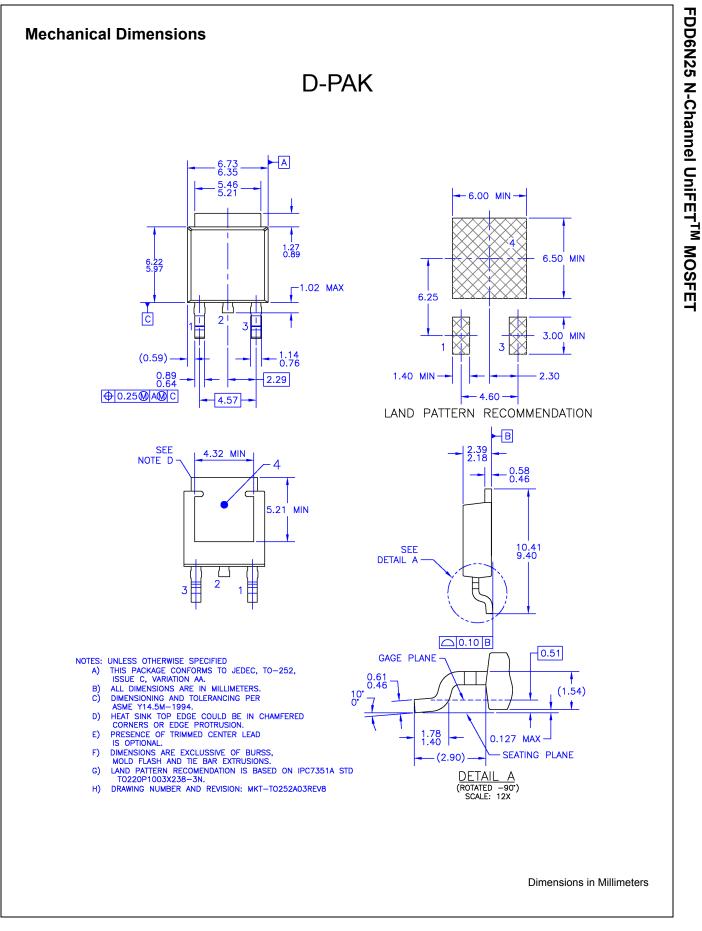


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